

FDU6N25 N-Channel UniFET[™] MOSFET **250 V, 4.4 A, 1.1** Ω

Features

- $R_{DS(on)}$ = 0.9 Ω (Typ.) @ V_{GS} = 10 V, I_D = 2.2 A
- Low Gate Charge (Typ. 4.5 nC)
- Low C_{rss} (Typ. 5 pF)
- 100% Avalanche Tested

Applications

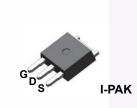
- LCD/LED/PDP TV
- Consumer Appliances
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

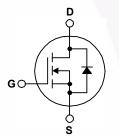
November 2013



Description

UniFETTM MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		Parameter	FDU6N25	Unit
V _{DSS}	Drain-Source Voltage		250	V
ID	Drain Current	- Continuous (T _C = 25°C) - Continuous (T _C = 100°C)	4.4 2.6	A A
I _{DM}	Drain Current	Drain Current - Pulsed (Note 1)		А
V _{GSS}	Gate-Source voltage		±30	V
E _{AS}	Single Pulsed Avalanch	ne Energy (Note 2)	12	mJ
I _{AR}	Avalanche Current	(Note 1)	4.4	Α
E _{AR}	Repetitive Avalanche Energy (5	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5	V/ns
P _D	Power Dissipation	(T _C = 25°C) - Derate Above 25°C	50 0.4	W W/°C
T _{J,} T _{STG}	Operating and Storage	-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C

Thermal Characteristics

FDU6N25 Rev. C1

Symbol	Parameter	FDU6N25	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	2.5	°C/W
R _{0JA} Thermal Resistance, Junction-to-Ambient, Max.		110	°C/W

Part NumberTop MarkFDU6N25FDU6N25		Top Mark	Package	ckage Packing Method Reel Size		Ta	be Width	Qu	antity
		IPAK	IPAK Tube N/			N/A	70 units		
Electric	al Char	acteristics T _c = 25°C	unless otherwi	se noted.					
Symbol		Parameter		Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristics								
BV_{DSS}	Drain-Sour	rce Breakdown Voltage	V _{GS} =	V _{GS} = 0 V, I _D = 250 μA		250			V
ΔBV_{DSS} / ΔT_{J}	Breakdown Coefficient	n Voltage Temperature	I _D = 25	I_D = 250 µA, Referenced to 25°C			0.25		V/∘C
I _{DSS}	Zero Gate Voltage Drain Current			$V_{DS} = 250 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 200 \text{ V}, T_C = 125^{\circ}\text{C}$				1 10	μΑ μΑ
I _{GSSF}	Gate-Body	Leakage Current, Forwar	rd V _{GS} =	30 V, V _{DS} = 0 V				100	nA
I _{GSSR}	Gate-Body	Leakage Current, Revers	e V _{GS} =	-30 V, V _{DS} = 0 V				-100	nA
On Charac	teristics								
V _{GS(th)}	Gate Threshold Voltage		V _{DS} =	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance		V _{GS} =	V _{GS} = 10 V, I _D = 2.2 A			0.9	1.1	Ω
9 _{FS}	Forward T	ransconductance	V _{DS} =	40 V, I _D = 2.2 A			5.5		S
Dynamic C	haracterist	ics							
C _{iss}	Input Capa	acitance		25 V, V _{GS} = 0 V,			194	250	pF
C _{oss}	Output Ca	pacitance	f = 1 N	f = 1 MHz			38	50	pF
C _{rss}	Reverse T	ransfer Capacitance					5	8	pF
Switching	Characteris	stics							
t _{d(on)}	Turn-On D	elay Time		$V_{DD} = 125 \text{ V}, \text{ I}_{D} = 6 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{G} = 25 \Omega$			10	30	ns
t _r	Turn-On R	ise Time	V _{GS} =				25	60	ns
t _{d(off)}	Turn-Off D	elay Time					7	24	ns
t _f	Turn-Off Fa	all Time			(Note 4)		12	34	ns
Q _g	Total Gate	Charge	$V_{DS} = 200 \text{ V}, \text{ I}_{D} = 6 \text{ A},$ $V_{GS} = 10 \text{ V}$				4.5	6	nC
Q _{gs}	Gate-Sour	ce Charge				1.5		nC	
Q _{gd}	Gate-Drair	n Charge		(Note 4)			1.8		nC
Drain-Sou	rce Diode C	haracteristics and Maxir	num Rating	js					
I _S Maximum Continuous Drain-Source Did			Diode Forw	ard Current				4.4	Α
I _{SM}	Maximum Pulsed Drain-Source Diode F		e Forward (Forward Current				18	Α
V _{SD}	Drain-Sou	rce Diode Forward Voltage	e V _{GS} =	0 V, I _S = 4.4 A,				1.4	V
t _{rr}	Reverse R	ecovery Time		$V_{GS} = 0 V, I_S = 4.4 A,$ $V_{GS} = 0 V, I_S = 6 A$			145		ns
Q _{rr}	Reverse R	ecovery Charge	dl _F /dt	=100 Ā/μs			0.55		μC

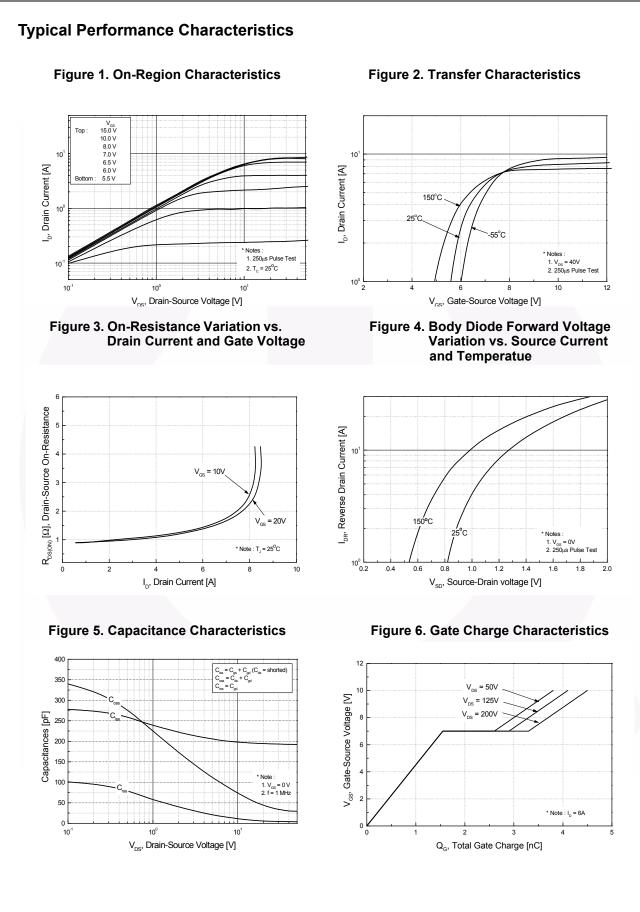
Notes:

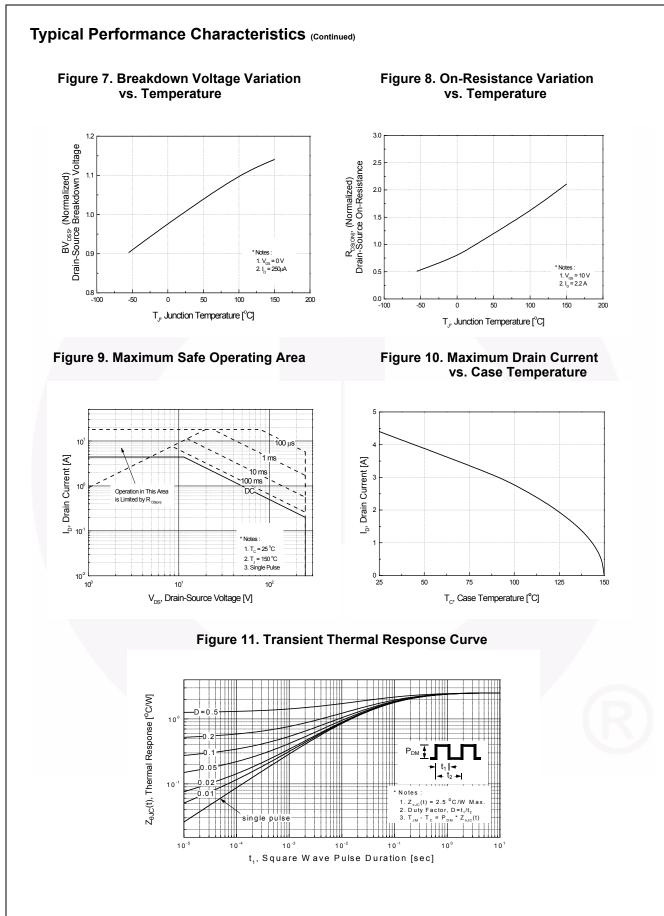
1. Repetitive rating: pulse-width limited by maximum junction temperature.

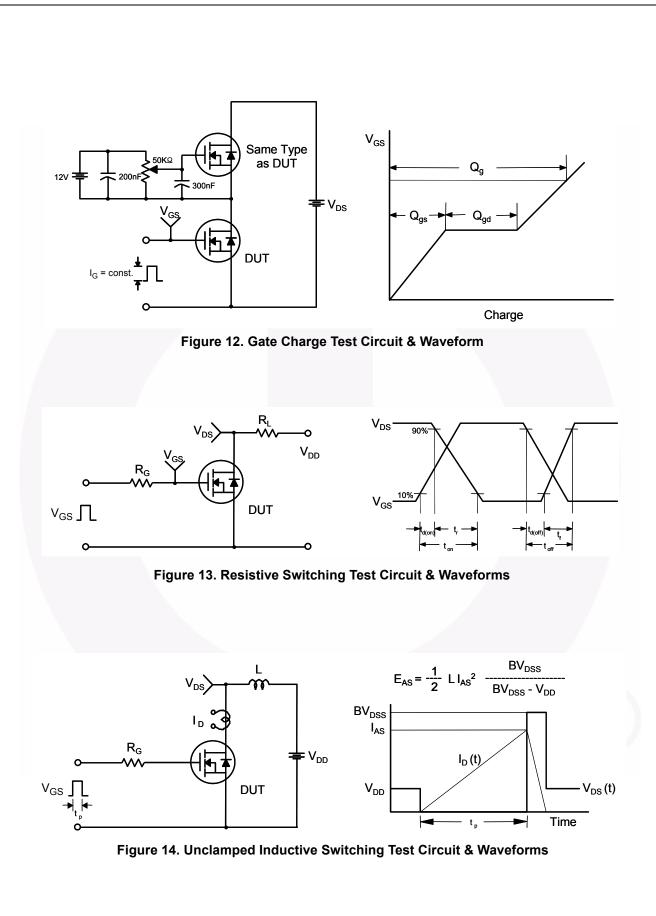
2. L = 1.2 mH, I_{AS} = 4.4 A, V_{DD} = 50 V, R_G = 25 $\Omega,$ starting T_J = 25°C.

3. I_{SD} \leq 4.4 A, di/dt \leq 200 A/µs, V_{DD} \leq BV_{DSS}, starting T_J = 25°C.

4. Essentially Independent of Operating Temperature Typical Characteristics

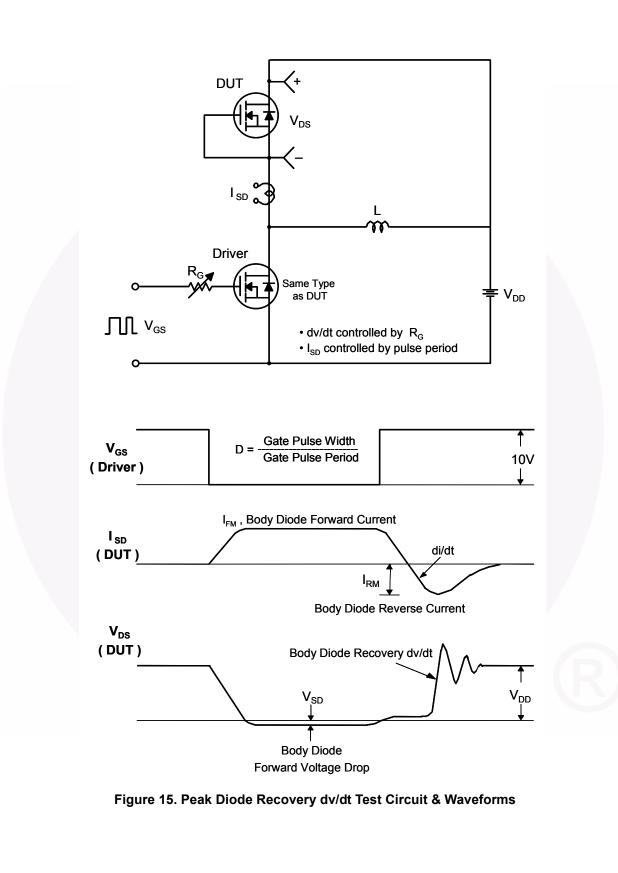


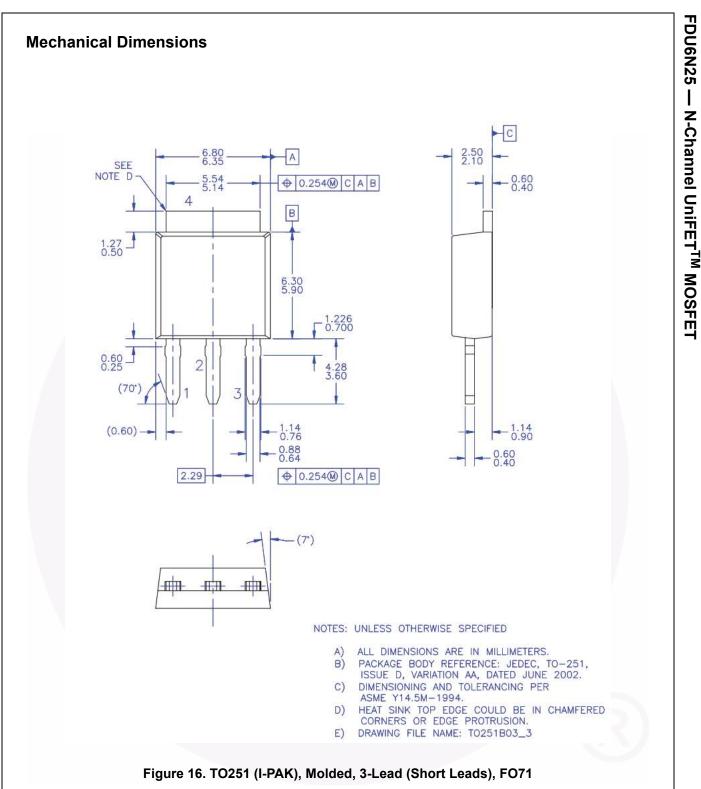




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